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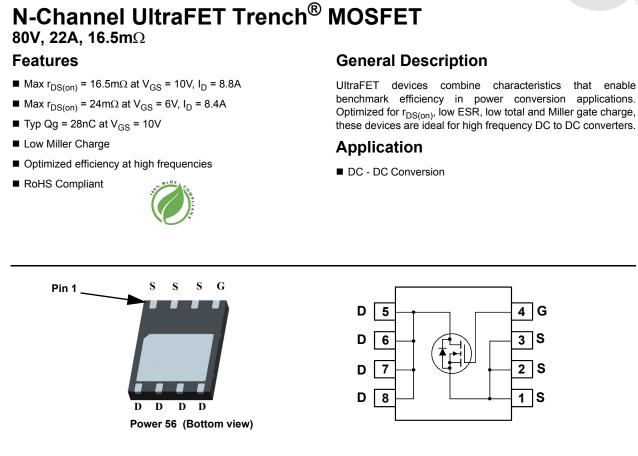
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MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			80	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25°C		22		
	-Continuous (Silicon limited)	T _C = 25°C		48	^	
	-Continuous	T _A = 25°C	(Note 1a)	8.8	Α	
	-Pulsed			50		
P _D	Power Dissipation	T _C = 25°C		78	W	
	Power Dissipation	T _A = 25°C	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

FAIRCHILD

FDMS3572

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.6	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/vv

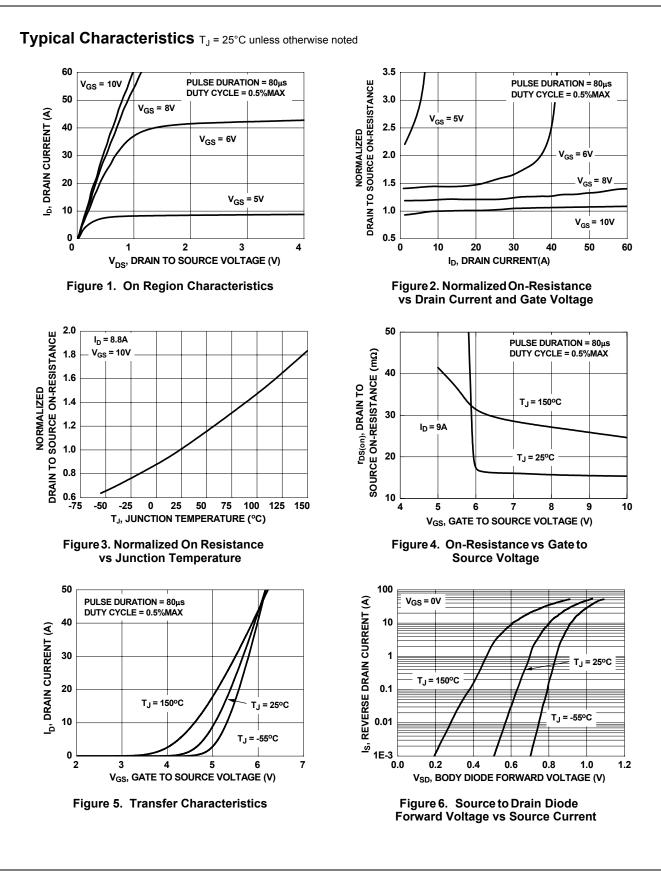
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS3572	FDMS3572	Power 56	13"	12mm	3000 units

Cteristics Drain to Source Breakdown Voltage Breakdown Voltage Temperature	I _D = 250μA, V _{GS} = 0V				
Drain to Source Breakdown Voltage	1 - 250.0 $1 - 0.0$				
	$I_{D} = 250 \mu A, V_{CS} = 0 V$	80			V
Coefficient	$I_D = 250 \mu A$, referenced to 25°C		76		mV/°C
Zero Gate Voltage Drain Current	V _{DS} = 64V, V _{GS} = 0V			1	μA
Gate to Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V			±100	nA
cteristics					
	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	3.2	4	V
Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		-11		mV/°C
· ·	V _{GS} = 10V, I _D = 8.8A		13.5	16.5	
Drain to Source On Resistance	V _{GS} = 6V, I _D = 8.4A		18.3	24	mΩ
	V_{GS} = 10V, I_{D} = 8.8A, T_{J} = 125°C		22.2	29	
Forward Transconductance	V _{DS} = 10V, I _D = 8.8A		23		S
Characteristics					
Input Capacitance			1870	2490	pF
Output Capacitance			275	365	pF
			78	120	pF
Gate Resistance	f = 1MHz		1.3		Ω
Characteristics					
Turn-On Delay Time			11	20	ns
Rise Time			13	24	ns
Turn-Off Delay Time	$V_{\rm GS} = 10V, R_{\rm GEN} = 002$		24	39	ns
Fall Time			12	22	ns
Total Gate Charge at 10V	$V_{GS} = 0V$ to 10V $V_{DD} = 40V$		28	40	nC
Gate to Source Gate Charge	I _D = 8.8A		9		nC
Gate to Drain "Miller" Charge			8		nC
rce Diode Characteristics					
	V _{GS} = 0V, I _S = 8.8A (Note 2)		0.8	1.2	V
Reverse Recovery Time			43	65	ns
Reverse Recovery Charge	$I_F = 8.8A$, dl/dt = 100A/µs		71	107	nC
	Gate to Source Leakage Current Cteristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller" Charge rce Diode Characteristics Source to Drain Diode Forward Voltage Reverse Recovery Time	Gate to Source Leakage Current $V_{GS} = \pm 20V, V_{DS} = 0V$ cteristicsGate to Source Threshold Voltage Temperature Coefficient $I_D = 250\mu$ A, referenced to 25° CDrain to Source On Resistance $V_{GS} = 10V, I_D = 8.8A$ Drain to Source On Resistance $V_{GS} = 10V, I_D = 8.8A$ Drain to Source On Resistance $V_{GS} = 10V, I_D = 8.8A$ Drain to Source On Resistance $V_{GS} = 10V, I_D = 8.8A$ Drain to Source On Resistance $V_{DS} = 10V, I_D = 8.8A$ Drain to Source On Resistance $V_{DS} = 10V, I_D = 8.8A$ Drain to Source On Resistance $V_{DS} = 10V, I_D = 8.8A$ CharacteristicsInput CapacitanceOutput Capacitance $V_{DS} = 40V, V_{GS} = 0V, f = 1MHz$ CharacteristicsImput CapacitanceTurn-On Delay Time $V_{DD} = 40V, I_D = 8.8A$ Rise Time $V_{GS} = 10V, I_D = 8.8A$ Turn-Off Delay Time $V_{GS} = 10V, I_D = 8.8A$ Fall Time $V_{DD} = 40V, I_D = 8.8A$ Gate to Source Gate Charge $I_D = 8.8A$ Gate to Drain "Miller" Charge $I_D = 8.8A$ Source to Drain Diode Forward Voltage $V_{GS} = 0V, I_S = 8.8A$ (Note 2)Reverse Recovery Time $I_r = 8.8A$ di/dt = 100A/us	Gate to Source Leakage Current $V_{GS} = \pm 20V, V_{DS} = 0V$ CteristicsGate to Source Threshold Voltage Temperature Coefficient $V_{GS} = V_{DS}, I_D = 250\muA$ 2Gate to Source Threshold Voltage Temperature Coefficient $I_D = 250\muA, referenced to 25^{\circ}C$ 2Drain to Source On Resistance $V_{GS} = 10V, I_D = 8.8A$ 2VGS = 10V, I_D = 8.8A, V_{GS} = 6V, I_D = 8.8A, T_J = 125^{\circ}C7Forward Transconductance $V_{DS} = 10V, I_D = 8.8A$ 2CharacteristicsInput Capacitance $V_{DS} = 40V, V_{GS} = 0V, f = 1MHz$ Output Capacitance $f = 1MHz$ 2Gate Resistance $f = 1MHz$ 2Characteristics72Turn-On Delay Time $V_{DS} = 40V, I_D = 8.8A$ 2Fall Time $V_{DS} = 10V, I_D = 8.8A$ 2Turn-Off Delay Time $V_{GS} = 10V, R_{GEN} = 6\Omega$ 2Fall Time $V_{DS} = 40V, I_D = 8.8A$ 2Gate to Source Gate Charge $I_D = 8.8A$ 2Gate to Drain "Miller" Charge $V_{GS} = 0V, I_S = 8.8A$ (Note 2)Reverse Recovery Time $I_F = 8.8A$ di/dt = 100A/us	Gate to Source Leakage Current $V_{GS} = \pm 20V, V_{DS} = 0V$ CteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}$. $I_D = 250\mu$ A23.2Gate to Source Threshold Voltage $I_D = 250\mu$ A, referenced to 25° C-11Temperature Coefficient $V_{GS} = 10V, I_D = 8.8A$ 13.5Drain to Source On Resistance $V_{GS} = 6V, I_D = 8.4A$ 18.3V_{GS} = 10V, I_D = 8.8A, T_J = 125^{\circ}C22.2Forward Transconductance $V_{DS} = 10V, I_D = 8.8A$ 23CharacteristicsInput Capacitance $V_{DS} = 40V, V_{GS} = 0V, f_T = 10Hz$ Output Capacitance $V_{DS} = 40V, V_{GS} = 0V, f_T = 10Hz$ 1870Output Capacitance $F = 1MHz$ 1.3CharacteristicsTurn-On Delay Time $V_{DD} = 40V, I_D = 8.8A$ 13Turn-Off Delay Time $V_{GS} = 10V, R_{GEN} = 6\Omega$ 24Fall Time121212Total Gate Charge at $10V$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 40V$ 28Gate to Duran "Miller" Charge $Reverse Recovery Time$ 843Kree Diode Characteristics $Reverse Recovery Time$ $V_{GS} = 0V, I_S = 8.8A$ 9Gate to Drain Diode Forward Voltage $V_{GS} = 0V, I_S = 8.8A$ (Note 2)0.8Reverse Recovery Time $V_{CS} = 0V, I_S = 8.8A$ 43	Gate to Source Leakage Current $V_{GS} = \pm 20V, V_{DS} = 0V$ ± 100 cteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250\muA$ 23.24Gate to Source Threshold Voltage $I_D = 250\muA$, referenced to $25^{\circ}C$ -111Temperature Coefficient $I_D = 250\muA$, referenced to $25^{\circ}C$ -111Drain to Source On Resistance $V_{GS} = 10V, I_D = 8.8A$ 13.516.5Drain to Source On Resistance $V_{GS} = 10V, I_D = 8.8A$ 13.516.5Verse Transconductance $V_{DS} = 10V, I_D = 8.8A$ 2323CharacteristicsInput Capacitance $V_{DS} = 40V, V_{GS} = 0V, f = 1MHz$ 18702490Output Capacitance $f = 1MHz$ 1.3120Gate Resistance $f = 1MHz$ 1.3120CharacteristicsTurn-On Delay Time $V_{DD} = 40V, I_D = 8.8A$ 1324Turn-Off Delay Time $V_{GS} = 0V, I_D = 40V, I_D = 40V$ 2840Gate to Source Gate Charge $I_D = 8.8A$ 91222Total Gate Charge at $10V$ $V_{GS} = 0V, I_S = 8.8A$ 993Gate to Drain "Miller" Charge8933rec Diode CharacteristicsSource to Drain Diode Forward Voltage $V_{GS} = 0V, I_S = 8.8A$ (Note 2)0.81.2Reverse Recovery Time $I_r = 8.8A$ di/dt = $100A/u_S$ 4365

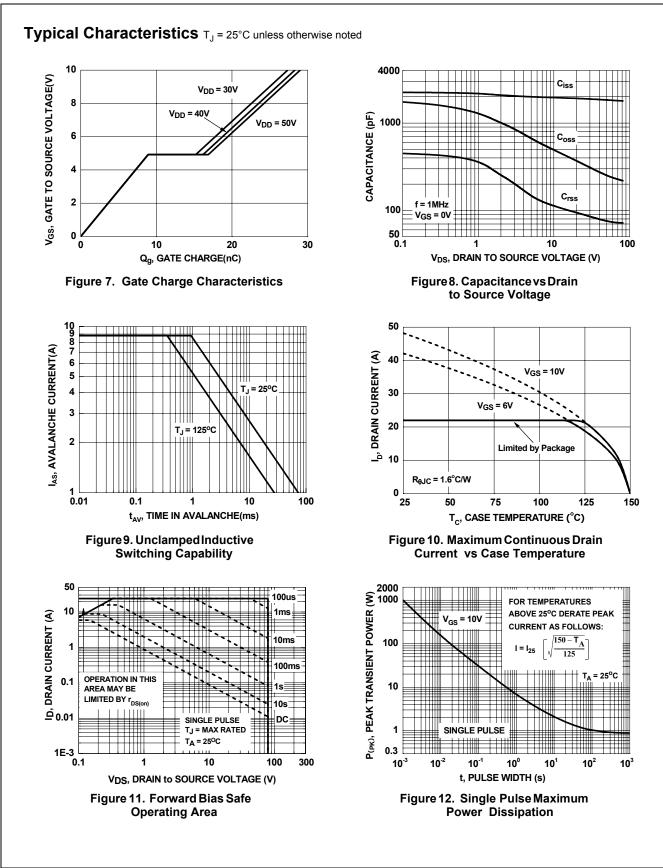
2: Pulse Test: Pulse Width < 300µs, Duty cycle < 2.0%.

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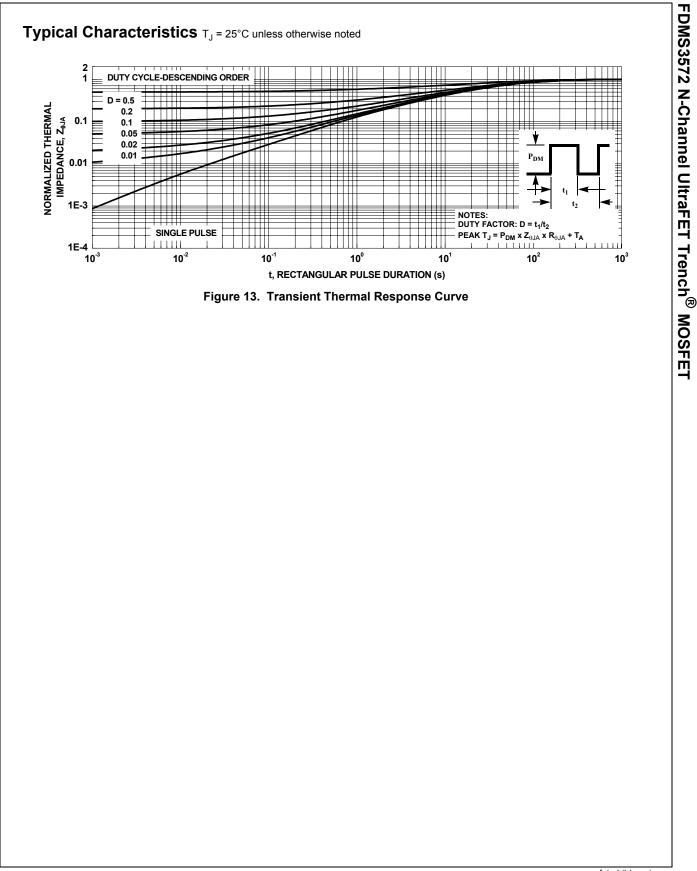


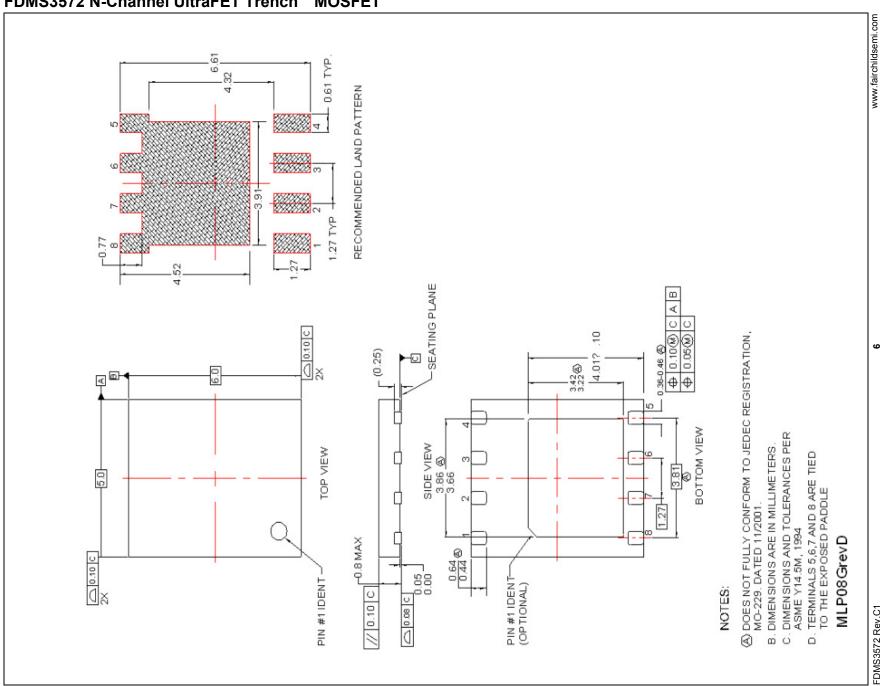


FDMS3572 Rev.C1

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FDMS3572 N-Channel UltraFET Trench[®] MOSFET

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